



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re patent application of:

Jarrett L. RINALDI, et al.

Serial No.: 09/965,234

Group Art Unit: 2827

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Examiner: J. Mitchell

FOR: MULTI-STACK SURFACE MOUNT LIGHT EMITTING DIODES

**PRELIMINARY AMENDMENT**

Assistant Commissioner for Patents  
Washington, DC 20231

Sir:

Preliminary to examination of the above-referenced application, please amend the application as follows:

**IN THE CLAIMS:**

Please cancel claims 13-20 without prejudice or disclaimer and add the following new claims:

- 21. A surface mount light emitting diode package, comprising:  
a housing;  
a plurality of light emitting diode die supported by the housing; and  
a plurality of electrical contacts on the outside of the housing, said  
contacts adapted for surface mounting to a circuit board and providing electrical signals  
to said plurality of light emitting diode die.
22. The surface mount light emitting diode package as recited in claim 21,  
wherein the plurality of light emitting diode die comprise a stack of at least two die  
arranged in a line.